

Development of an integrated CMOS detector for radon activity measurement and neutron dosimetry

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Abstract. The development of pixel CMOS sensors for particle tracking in high energy physics has led to promising applications for dosimetry. We present the last results in electronic monitoring of atmospheric radon with the new system-on-chip AlphaRad, as well as highly efficient detection of fast neutrons with a megapixel Active Pixel Sensor of the MIMOSA generation.

1 Introduction

The IPHC at Strasbourg (Institut Pluridisciplinaire Hubert Curien) has a world-class expertise in CMOS pixel sensors for charged particles tracking [1]. These VLSI monolithic sensors proved high efficiency for charged particles (>99%), high spatial resolution ($\sigma_{xy} \sim 1 \mu\text{m}$), high speed (5 MHz/pix), low power and low cost (industrial processes with commercial silicon). These pixel devices will be used in the next generation of vertex detectors [1].

Turning to dosimetry applications, we present here the detection of α -particles (atmospheric ^{222}Rn) and fast neutrons through proton recoils with a CMOS pixel chip. Devoted especially to these applications, a new system-on-chip in 0.6 micron CMOS technology has also been designed at the IPHC. The AlphaRad chip [2], with an active area of $5 \times 5 \text{ mm}^2$ and working up to 300 kHz, shows nearly 100% efficiency with alpha emitting sources and a remarkably high counting rate of 1.2 MBq/cm^2 . Both chips are used at room temperature.

1.1 Application to atmospheric radon

The first promising application of the AlphaRad chip is the monitoring of atmospheric radon with an inexpensive and fully electronic system. The present prototype is based on independent AlphaRad chips mounted on a printed-circuit board of the same size as non-electronic monitors currently used for radon survey (electrets), typically 6 cm diameter \times 3 cm height. The electronic board includes a numeric block based on a Xilinx processor. In a fully passive counting mode, the device detects the total alpha-activity of the neutral ^{222}Rn plus its two daughters ^{218}Po and ^{214}Po . The system is already twenty times faster than a previously published experiment [3] based on CMOS pixels, and an excellent linearity has been demonstrated on a special test bench for high radon activities. The future Electronic Radon Monitor will include collection of the Po daughters, providing radon monitoring at low voltage conditions (5 V), long-term and standalone operation without any external PC.

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1.2 Application to fast neutrons

Neutron detection is the second application, as CMOS sensors present another feature of extremely high interest: a nearly complete γ -transparency. From experiments with a calibrated fast neutron source of $^{241}\text{AmBe}$ and with a polyethylene radiator, a very good efficiency of 1.5×10^{-3} p/n has been obtained. The future detector will have real-time response and γ -transparency, high efficiency in a small volume at a reasonable cost. The numerous applications in the field of neutron detection include dosimetry in nuclear plants or radioactive waste facilities, at medical cyclotrons as well as neutron beams.

2 From pixels to the AlphaRad chip

Since 1999, integrated Active Pixel Systems have shown excellent features for vertexing purposes [1]. The first application to dosimetry was performed with a true CMOS pixel sensor [2], leading to the development of a dedicated chip: the AlphaRad chip is manufactured with a $14 \mu\text{m}$ thick epitaxial layer on a standard silicon substrate, allowing efficient detection of all charged particles able to cross the SiO_2 passivation layer ($6 \mu\text{m}$ thick). Charge collection is obtained by pure diffusion of carriers (in less than 500 ns) followed by detection on an array of micro-diodes distant of $80 \mu\text{m}$. As the 2048 diodes are connected in parallel, a very fast detection cycle is possible, up to 300 kHz for the full area ($2.5 \times 5 \text{ mm}^2$) with a negligible dead time. Thanks to a signal/noise ratio of 70, the measured efficiency [3] of the AlphaRad chip to 5 MeV α -particles is close to 100%.

3 Electronic radon monitoring

The very first detection of atmospheric radon by a CMOS pixel sensor [2] was published in 2004, establishing the proof-of-principle of this measurement. However, the small sensitive area of the MIMOSA-I detector ($1.2 \times 1.2 \text{ mm}^2$) implies a several-days long recording for typical indoor activities ($\sim 1 \text{ kBq/m}^3$). Observing that the true pixel structure is not

really needed for this application, the dedicated system-on-chip AlphaRad [3] was designed with a larger sensitive area and a fully parallel readout with a single numeric output, allowing a fast reset cycle up to 300 kHz, a promising feature for neutron beam monitoring (see section 4). For radon purposes, we present here a nearly complete device with several independent AlphaRad chips running in parallel on a portable board, ready for a fully standalone mode of operation.

3.1 Hardware

In the present configuration, the printed circuit board of 5.2 cm diameter supports three AlphaRad chips running in parallel, and a complete processing of the analog signal (allowing pile-up separation) is performed through a Xilinx FPGA, after analog-to-digital conversion with an 8-bits ADC (32 MHz). To avoid unwanted couplings between the two independent matrices of each chip, a single matrix per chip is used here, thus a total sensitive area of $S = 3 \times (5 \times 2.5 \text{ mm}^2)$.

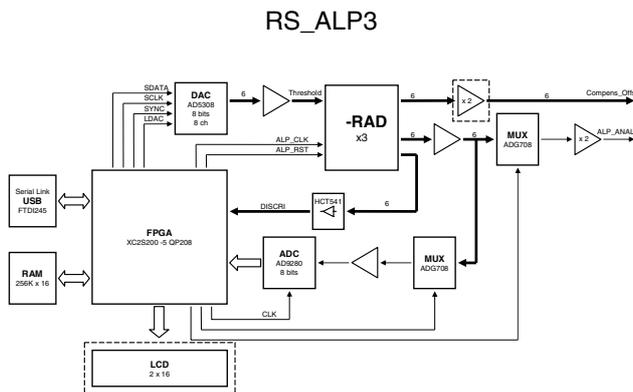


Fig. 1. Synoptic of the readout board for three AlphaRad chips running in parallel.

3.2 Linearity tests

Low activity: The electronic board is inserted into the closed tank of 0.224 m^3 used at the IPHC, together with an ionisation chamber (IC) as a control device. The ^{222}Rn gas, injected from a standard ^{226}Ra source, has a mean activity of $A_v = 1100 \text{ Bq/m}^3$ (typical indoor critical level). As no filtration of the daughter elements of Rn is performed, the detected alpha activity is the sum of three emitters, ^{222}Rn plus the two short-lived ^{218}Po and ^{214}Po [2]. For this volumic activity A_v , the measured surface counting rate (in a fully passive counting mode, e.g., without forced air circulation) is $A_s = 6.57 \pm 0.40 \alpha/\text{h}$ (figure 2). This reproducible figure, already twenty times higher than the previously published one [2], will be enhanced again with the next AlphaRad chip (with an active area of 0.5 cm^2 per chip).

We define hereafter a Conversion factor to Volumic Activity (labelled F) through the relationship $A_v = F \cdot A_s$. This CVA may be expressed in different units, e.g., kBq/m^3 for a given area, and a sampling time which has to be precisely defined. For a better comparison with the ionisation chamber,

we choose to express our results in the same acquisition step ($\Delta t_{\text{IC}} = 10 \text{ min}$). With this convention, we write our counting rate $A_s = 1.095 \pm 0.067$ ($\Delta t_{\text{sampl}} = 10 \text{ min}$) for 1.1 kBq/m^3 , hence a CVA of $F = 1.03 \pm 0.06 \text{ m}^{-1}$ ($\Delta t_{\text{sampl}} = 10 \text{ min}$, $S = 0.375 \text{ cm}^2$).

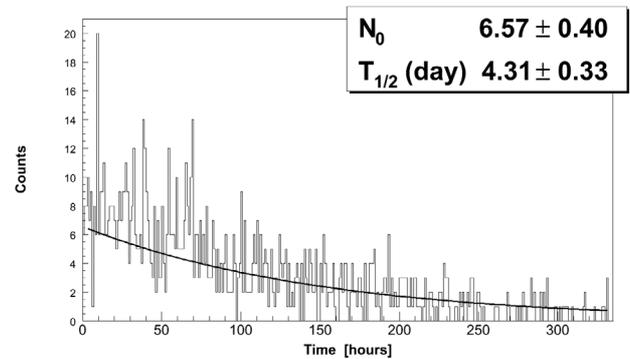


Fig. 2. A ten days fit of the recorded data at 1100 Bq/m^3 , showing the large detection fluctuations and the decay of Rn.

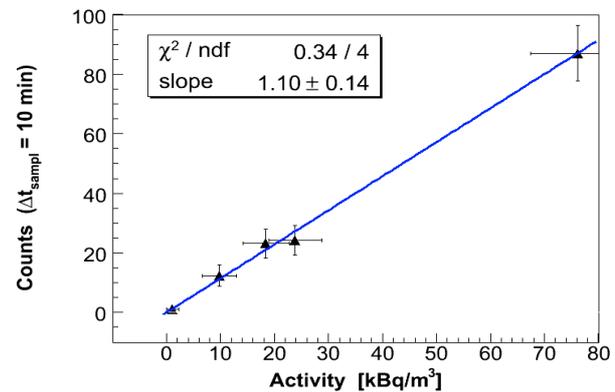


Fig. 3. Linearity of the 3-chips board, in the low activity IPHC tank (first point at 1.1 kBq/m^3) cumulated with four measurements in the high activity BACCARA bench (from 10–80 kBq/m^3).

High activity: For a satisfactory test of linearity, better conditions were required, as the IPHC test bench offers a single volumic activity (of only 1100 Bq/m^3) and requires several days of delay for regeneration of the Ra/Rn source. The LPMA laboratory of the IRSN (Institut de Radioprotection et de Sûreté Nucléaire) in Saclay (France) is equipped with a test bench of large volume (1 m^3) and high radon activities [4]. This facility offers the same conditions as the IPHC Strasbourg (slow Rn decay in closed tank) or, on request, constant radon concentration. The main result (figure 3) is an excellent linearity (correlation coefficient of 0.95) over the range 1.1 kBq/m^3 to 80 kBq/m^3 . The least squares linear fit gives a comparable value for the CVA factor: $F' = 1.15 \pm 0.15 \text{ m}^{-1}$ ($\Delta t_{\text{sampl}} = 10 \text{ min}$).

4 Fast neutrons

Our CMOS sensors are able to detect neutrons over the full range of energies, as they may be converted into α/t particles (through B/Li foils) or into recoil protons in (n,p) elastic reactions on hydrogen-rich converters. Besides fast response and high efficiency to charged particles, these sensors offer the nice feature of being almost free of γ -contamination. The following measurements were carried out at another IRSN facility: the LDME (Laboratoire de Dosimétrie et Mesure de Neutrons) located in Cadarache (France).

4.1 Experimental set-up

The radiator is a polyethylene foil of 0.9 mm thickness glued in front of an aluminium box containing the MIMOSA V chip [1]. With 512×512 pixels $17 \mu\text{m}$ apart, the sensitive area is of slightly less than 1 cm^2 . The acquisition system is based on a local board including a FPGA driven by an external PC. Consecutive frames (of 262 144 pixels each) are subtracted two by two, in order to cancel the fixed pattern noise, and an adjustable threshold allows to reduce the recorded data flow which otherwise would be of 10.5 MBytes/s. From preliminary off-source runs, one measures the noise distribution of each pixel. The threshold is set well above five standard deviations of the mean noise. The “Van Gogh” irradiator at Cadarache provides a calibrated neutron field from a 10 Ci AmBe source, installed on a measurement plateau located at 3.2 m above ground to avoid reflected neutrons. Data from the ISO-certified AmBe source were taken at several distances between 40 cm and 100 cm (with laser-monitoring of the source to detector distance).

4.2 Results

Fluence: The cluster-search algorithm starts with the recorded pixel showing the highest detected charge, then all neighbouring pixels with a charge at least 5 times greater than their RMS noise are included, and the total charge is compared

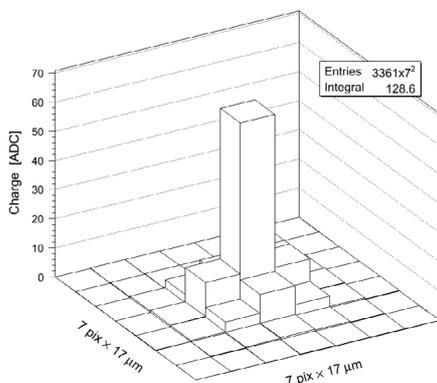


Fig. 4. The typical charge cluster from the recoil protons converted inside the polyethylene and detected by the CMOS pixels. 3361 clusters are averaged here.

to the mean noise inside the cluster to compute the signal to noise ratio (SNR). Figure 4 shows the typical cluster of adjacent pixels corresponding to the charge deposited by a single recoil proton hitting the epitaxial layer of the CMOS sensor. On average protons impinge the sensor at perpendicular incidence. At 75 cm distance, the sensor is crossed by a flux of $528 \text{ n}/(\text{s}\cdot\text{cm}^2)$, but only the fastest neutrons of the AmBe spectrum ($1.9 \text{ MeV} < E_n < 11 \text{ MeV}$) generate visible proton, that is, protons able to escape the converter, cross the air layer separating the converter from the sensor and cross SiO_2 layers.

Straggling: At these energies, the elastic (n,p) diffusion is isotropic in the center-of-mass, and simulation indicates that the mean diffusion angle of the protons is 27° (from the neutron trajectory). Indeed, we could observe some isolated proton tracks at large angles, crossing in this case several adjacent pixels [5]. The cumulated detected charge follows a Landau distribution (straggling), as expected from MeV protons losing energy a thin silicon layer (fig. 5).

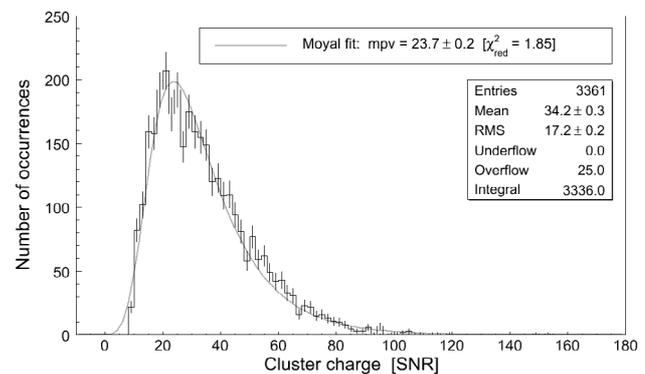


Fig. 5. The observed charge statistics, following the theoretical Landau distribution for thin detectors, and expressed here as a signal to noise ratio.

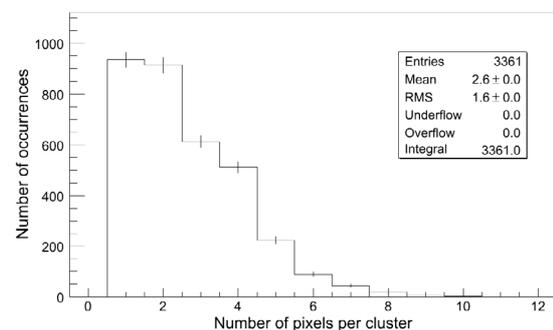


Fig. 6. The pixels-multiplicity distribution inside clusters, here at all cumulated distances.

Multiplicity: The distribution of the pixel multiplicity in each cluster is another figure of interest. The detected protons have a mean multiplicity of 2.5 pixels for a 5σ SNR cut, this multiplicity being quite uniform upon the whole detector. The observed data does not exactly follow the theoretical Poisson distribution (fig. 6), suggesting the presence of parasitic

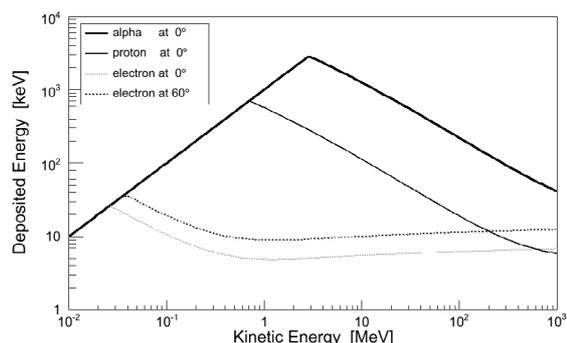


Fig. 7. A Bethe-Bloch calculation showing the excellent rejection of photoelectrons, even for the worst incident angle (60° , corresponding to the $14 \times 17 \times 17 \mu\text{m}^3$ pixel diagonal): in the energy range of interest (a few tens of keV set by the acquisition threshold to 10 MeV), the signal from protons or α -particles is always ten times above that of secondary electrons.

events, as can also be deduced from the efficiency analysis (see next section).

Photon contamination: It could be tempting to consider γ -photons as an important source of excess events, as we have roughly one photon per neutron in this kind of source. The photon dose $H^*(10)$ at 75 cm was measured to be $21 \pm 2 \mu\text{Sv/h}$. However, in a CMOS detector of only $14 \mu\text{m}$ sensitive thickness, we can safely rule out the presence of photon-induced events, even if one takes into account low-ionising electrons generated in the close vicinity of the sensor (aluminium box) by MeV photons. This very nice feature can be seen with a Bethe-Bloch calculation (fig. 7).

4.3 Efficiency

The most important parameter of such a neutron detector is its intrinsic efficiency, calculated as the ratio of detected protons over the flux of neutrons crossing it. Diffusion cross-section values and proton range calculations (in $(\text{CH}_2)_n$, air, SiO_2 and Si) show that only the last $85 \mu\text{m}$ of the polyethylene radiator can contribute to detectable protons, which must have a minimal energy of 950 keV to reach the sensitive volume [5]. From these considerations, the expected efficiency of our system (in the AmBe spectrum) should be of about 1.1×10^{-3} p/n. A more detailed Monte Carlo calculation with the MCNPX code leads again to $\varepsilon_{\text{MC}} = 1.1 \times 10^{-3}$ n/p [5]. Both calculations do not take into account inelastic reactions inside the detector itself (SiO_2 and Si) and the surrounding Al box.

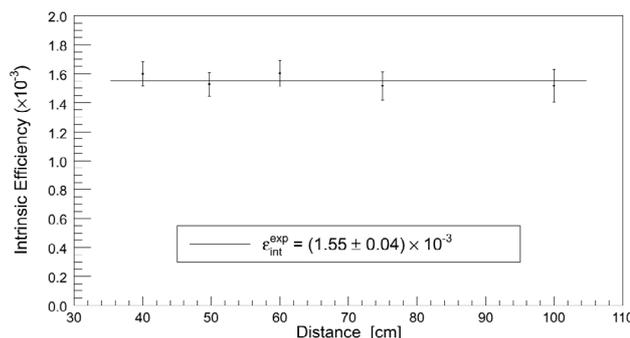


Fig. 8. The measured detection efficiency of the polyethylene/CMOS pixel system for fast neutrons from an AmBe source, over five distances.

Cumulating now all our data at all five distances, we obtain the slightly higher value of $\varepsilon_{\text{data}} = (1.55 \pm 0.04) \times 10^{-3}$. The mentioned error is purely statistic, and obviously, we have systematic contributions from the sensor itself (some lack of homogeneity), from inelastic scattering ((n,p) reactions in Si and the Al box) as well as scattered neutrons inside the box. More detailed simulations are underway, but at this stage, the measured efficiency is in good agreement with the calculated values, making this first achievement really promising.

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